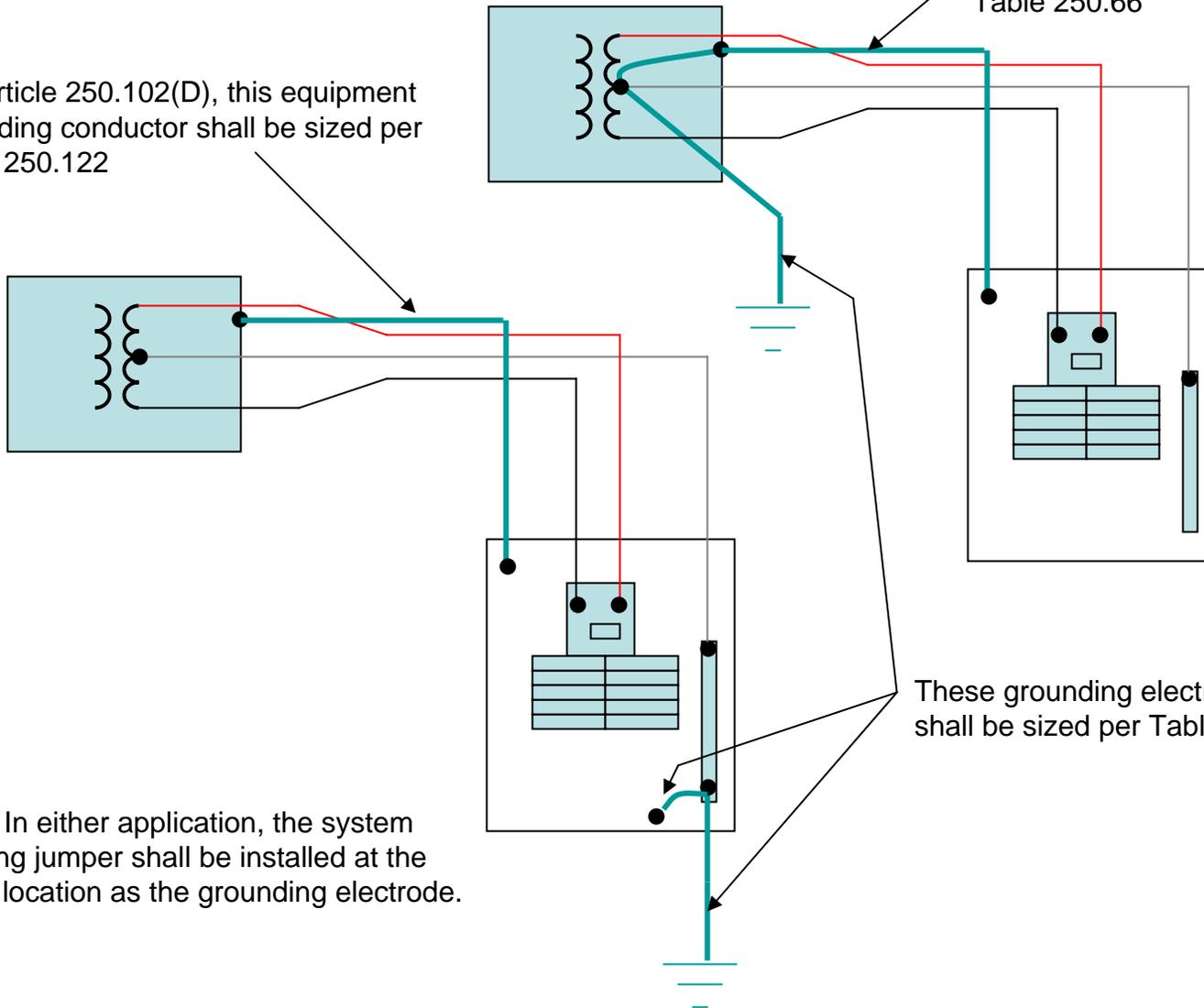


Grounding of Separately Derived Systems

Transformer versus first overcurrent device

Per Article 250.102(D), this equipment grounding conductor shall be sized per Table 250.122

Per Article 250.102(C), this equipment grounding conductor shall be sized per Table 250.66



These grounding electrode conductors shall be sized per Table 250.66

Note: In either application, the system bonding jumper shall be installed at the same location as the grounding electrode.